

December 2009 SupreMOS^M

FCP7N60N / FCPF7N60NT N-Channel MOSFET 600V, 6.8A, 0.52Ω

Features

- $R_{DS(on)} = 0.46\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 3.4A$
- Ultra Low Gate Charge (Typ.Qg = 17.8nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant



Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



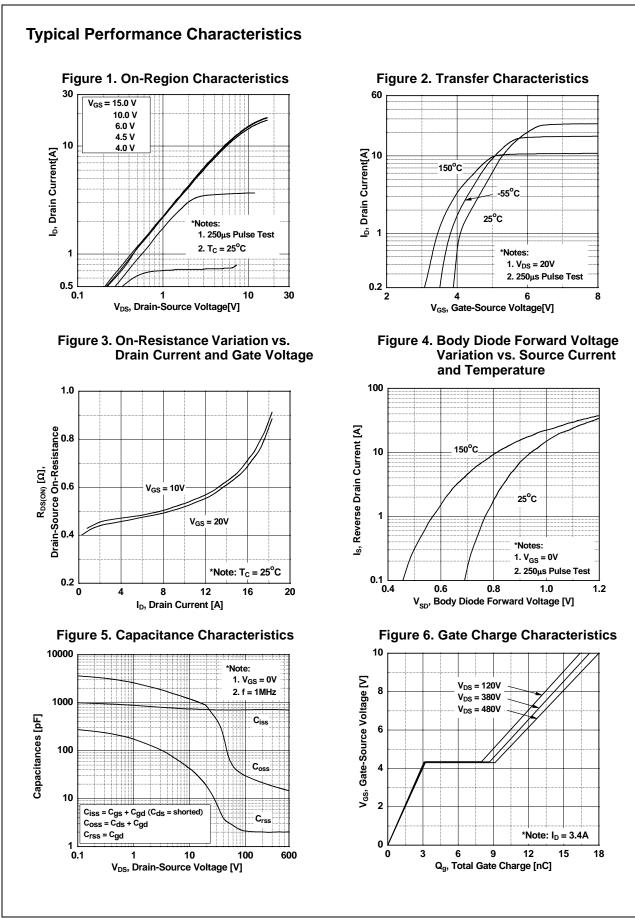
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

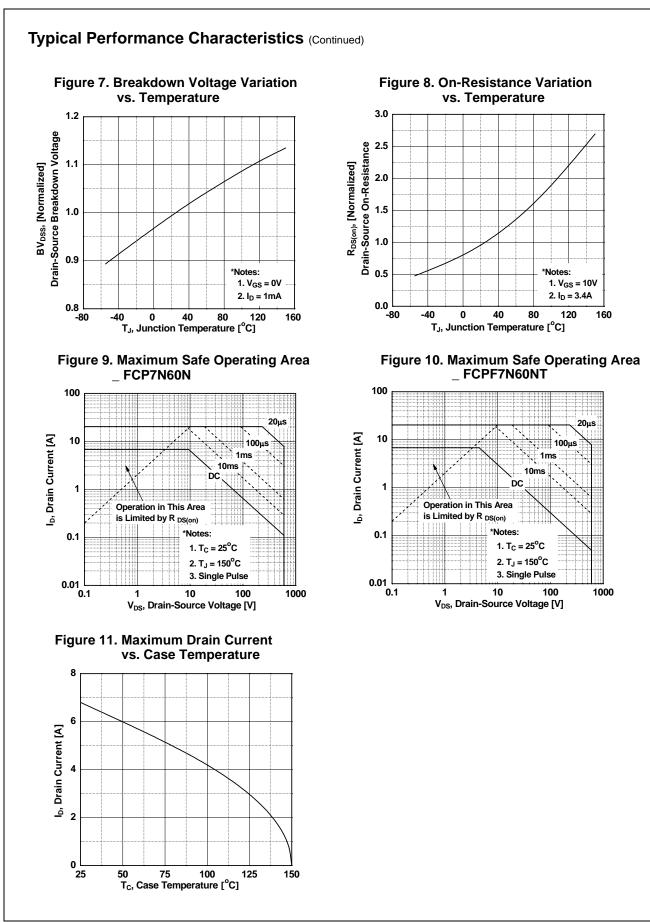
Symbol		Parameter		FCP7N60N	FCPF7N60NT	Units
V _{DSS}	Drain to Source Voltage			600		V
V _{GSS}	Gate to Source Voltage		±30		V	
I _D	Drain Current	-Continuous ($T_C = 25^{\circ}C$)		6.8	6.8*	۸
		-Continuous (T _C = 100 ^o C)		4.3	4.3*	A
I _{DM}	Drain Current	- Pulsed (No	ote 1)	20.4	20.4	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		79.4		mJ	
I _{AR}	Avalanche Current		6.8		А	
E _{AR}	Repetitive Avalanche Energy		0.6		mJ	
dv/dt	MOSFET dv/dt Ruggedness			100		V/ns
	Peak Diode Recovery dv/dt (Note 3)		4.9		V/ns	
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		64.1	30.5	W
		- Derate above 25°C		0.51	0.24	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C
Drain current li	mited by maximum junction temperatu	re				

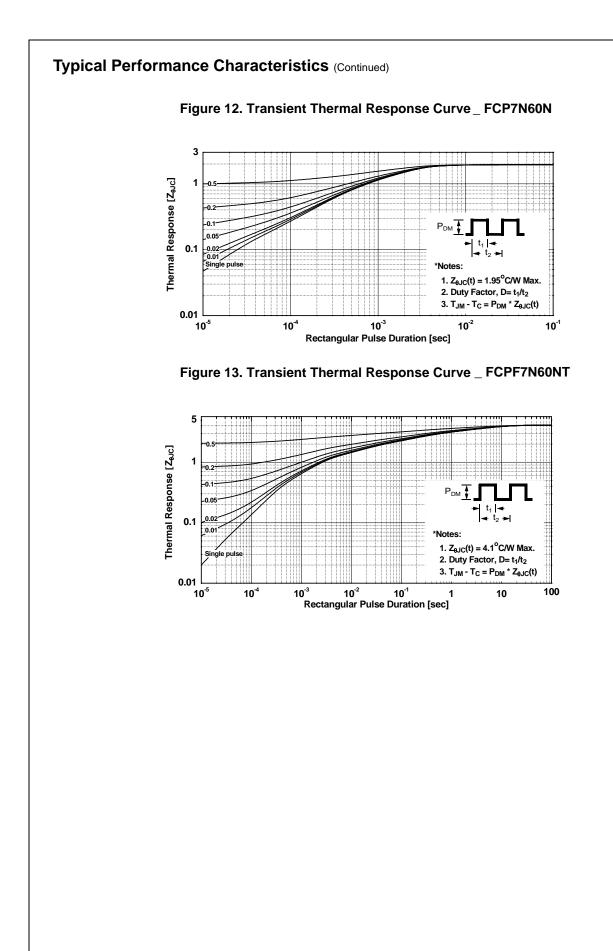
Thermal Characteristics

Symbol	Parameter		FCPF7N60NT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		4.1	
$R_{\theta CS}$	Thermal Resistance, Case to Heak Sink (Typical)		0.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	62.5	

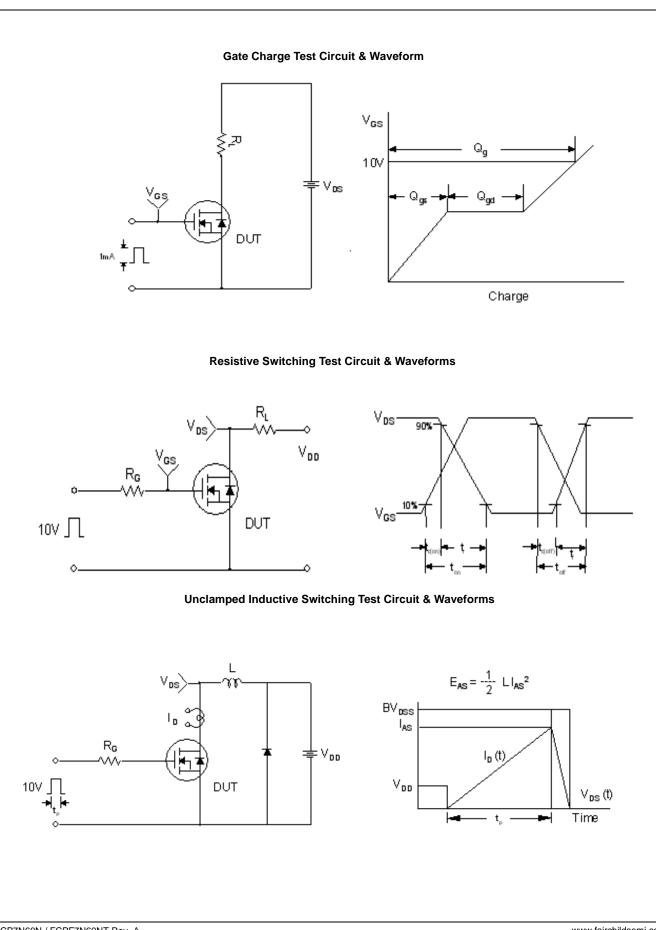
FCP7N FCPF7N	arking	Device	Package	e Reel Size	e Tape	e Width		Quantit	у
FCPF7N	60N	FCP7N60N	TO-220AI	в -		-		50	
		TO-220F	-		-		50		
Electrica	I Char	acteristics T _c =	25ºC unless o	therwise noted					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charac	cteristic	S							
BV _{DSS}	Drain to Source Breakdown Voltage		oltage	$I_{D} = 1 \text{mA}, V_{GS} = 0 \text{V}, T_{C} = 25^{\circ} \text{C}$		600	-	-	V
∆BV _{DSS}		reakdown Voltage Temperature		$I_D = 1$ mA, Referenced to 25°C					\ <i>u</i> 00
ΔT_J	Coefficient					-	0.6	-	V/ºC
1	Zoro C	ata Valtaga Drain Curr	ont	$V_{DS} = 480V, V_{GS} = 0V$		-	-	10	
DSS	SS Zero Gate Voltage Drain Current		ent	$V_{DS} = 480V, V_{GS} = 0V, T_{C} = 125^{\circ}C$		-	-	100	μA
GSS	Gate to Body Leakage Current		ıt	$V_{GS} = \pm 30V, V_{DS} = 0V$		-	-	±100	nA
On Charac	teristic	S							
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		2.0	-	4.0	V
R _{DS(on)}		Drain to Source On Res		$V_{GS} = 10V, I_D = 3.4A$		-	0.46	0.52	Ω
9 _{FS}	Forwar	vard Transconductance		$V_{\rm DS} = 20V, I_{\rm D} = 3.4A$			8.5	-	S
			I						
Dynamic C	1								
C _{iss}		apacitance		V _{DS} = 100V, V _{GS} = 0V f = 1MHz		-	719	960	pF
C _{oss}	-	Capacitance				-	30	40	pF
C _{rss}		e Transfer Capacitance				-	2.1	3.2	pF
C _{oss}		It Capacitance		$V_{DS} = 380V, V_{GS} = 0V, f = 1MHz$		-	17	-	pF
C _{oss} eff		tive Output Capacitance		$V_{DS} = 0V$ to 380V, $V_{GS} = 0V$		-	91	-	pF
Q _{g(tot)}		ate Charge at 10V	$V_{DS} = 380V, I_{D} = 3.4A$ $V_{GS} = 10V$ (Note 4)		-	17.8	35.6	nC	
Q _{gs}		Source Gate Charge			-	3.2	6.3	nC	
Q _{gd}		Drain "Miller" Charge			(Note 4)	-	6.0	11.9	nC
ESR	Equival	Equivalent Series Resistance (G-S) Drain Open			-	2.5	-	Ω	
Switching	Charac	teristics							
t _{d(on)}	Turn-Or	n Delay Time				-	12	24	ns
t _r	Turn-Or	n Rise Time		$V_{DD} = 380V, I_D = 3.4A$	A T	-	6	22	ns
	Turn-Of	f Delay Time		R _G = 4.7Ω (Note 4)		-	35	80	ns
t _{d(off)}	Turn-Of	f Fall Time				-	12	24	ns
t _{d(off)} t _f									
t _f	rce Dio	de Characteristic	S						1
_{t_f Drain-Sou}		de Characteristic		Forward Current		-	-	6.8	A
^t f Drain-Sou	Maximu	de Characteristic m Continuous Drain to m Pulsed Drain to Sou	Source Diode			-	-	6.8 20.4	A
t _f Drain-Sou I _S I _{SM}	Maximu Maximu	m Continuous Drain to	Source Diode	vard Current					
^t f Drain-Sou	Maximu Maximu Drain to	m Continuous Drain to m Pulsed Drain to Sou	Source Diode Irce Diode Forv d Voltage			-	- - - 211	20.4	Α





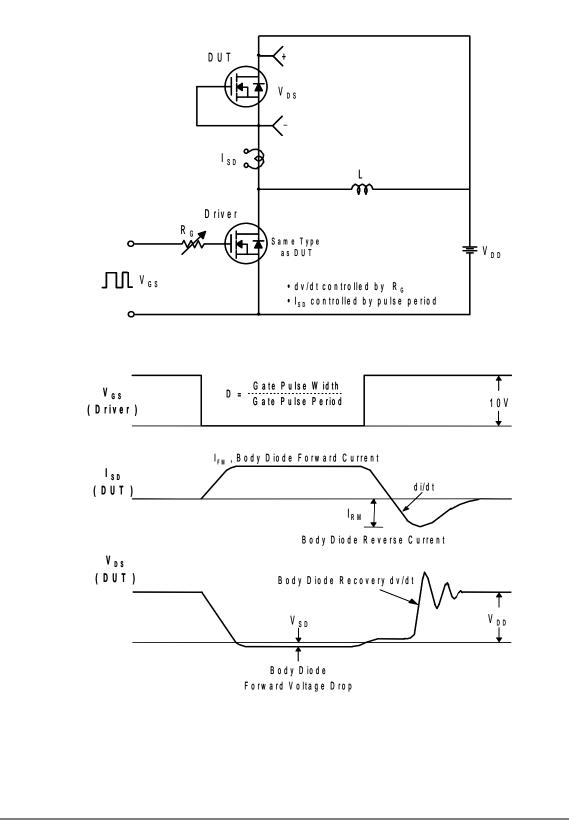


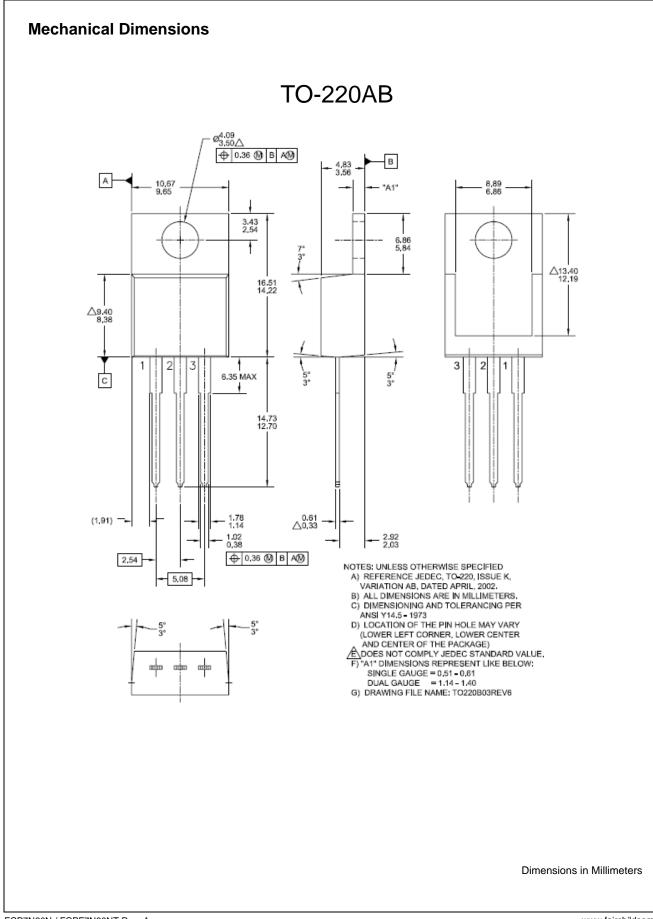


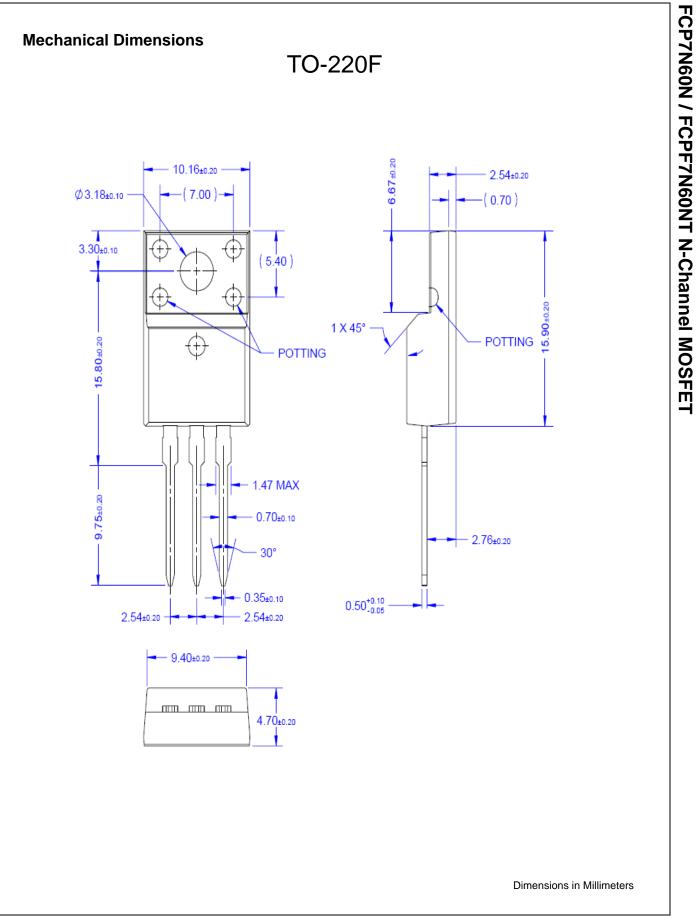


FCP7N60N / FCPF7N60NT N-Channel MOSFET











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